

This notice is to inform you of a change that will be made to certain ADI products (see Appendix A) that you may have purchased in the last 2 years. **Any inquiries or requests with this PCN (additional data or samples) must be sent to ADI within 30 days of publication date.** ADI contact information is listed below.

PCN Title:	Expanding waferfab source to Powerchip/Taiwan (Fab101) for MAX38640BENT06+ (CP25)
Publication Date:	05-May-2023
Effectivity Date:	07-Aug-2023 <i>(the earliest date that a customer could expect to receive changed material)</i>
Revision Description:	

Description Of Change:

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MAX38640BENT06+
Current waferfab source at Analog Devices/USA (ADBN)
ADBN wafer size is 8-inch

Reason For Change:

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Adding Fab101 is to ensure supply continuity.
ADI has achieved equivalency for Fab101 vs current fab.
Fab101 qualification report is attached.

There are no changes to Form/Fit/Function of the device.

Impact of the change (positive or negative) on fit, form, function & reliability:**Product Identification (this section will describe how to identify the changed material):****Summary of Supporting Information:****Supporting Documents:****ADI Contact Information:**

For questions on this PCN, please send an email to the regional contacts below or contact your local ADI sales representatives.

Americas:	Europe:	Japan:	Korea:	Rest of Asia:
PCN_Americas@analog.com	PCN_Europe@analog.com	PCN_Japan@analog.com	PCN_Korea@analog.com	PCN_ROA@analog.com

Appendix A - Impacted items, see csv PN listing in PCN Zip file